Pb Free Product



NCE N-Channel Enhancement Mode Power MOSFET

Description

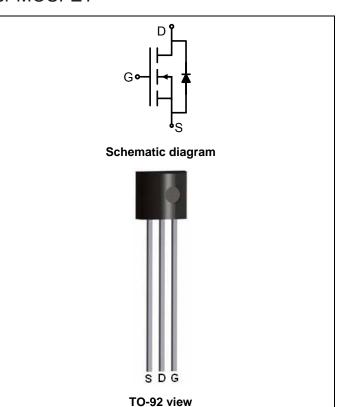
The NCE0202Z uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- V_{DS} = 200V, I_D =2A $R_{DS(ON)}$ < 580mΩ @ V_{GS} =10V (Typ:520mΩ)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|----------|----------------|-----------|------------|----------|
| 0202Z | NCE0202Z | TO-92 | - | - | - |

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|---------------------|------------|--|
| Drain-Source Voltage | V _{DS} | 200 | V |
| Gate-Source Voltage | V _{GS} | ±20 | V |
| Drain Current-Continuous | I _D | 2 | Α |
| Drain Current-Pulsed (Note 1) | I _{DM} | 8 | Α |
| Maximum Power Dissipation | P _D | 3 | W |
| Operating Junction and Storage Temperature Range | T_{J} , T_{STG} | -55 To 150 | $^{\circ}\!$ |

Thermal Characteristic

| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{	heta JA}$ | 41.7 | °C/W |
|--|----------------|------|------|
| , and the second | | 1 | 1 |

Electrical Characteristics (T_A=25 ℃ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|---------------------------------|-------------------|---|-----|-----|-----|------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | 200 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =200V,V _{GS} =0V | - | - | 1 | μA |



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NCE0202Z

| sate-Body Leakage Current I _{GSS} | | V _{GS} =±20V,V _{DS} =0V | - | - | ±100 | nA | | |
|--|---|---|-----|-----|------|----|--|--|
| On Characteristics (Note 3) | | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} ,I _D =250μA | 2.5 | 3.4 | 4.5 | V | | |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =2A | - | 520 | 580 | mΩ | | |
| Forward Transconductance | orward Transconductance g _{FS} V _{DS} | | - | 8 | - | S | | |
| Dynamic Characteristics (Note4) | | | | | | | | |
| Input Capacitance | C _{lss} | \/ -25\/\/ -0\/ | - | 580 | - | PF | | |
| Output Capacitance | C _{oss} | V_{DS} =25V, V_{GS} =0V, F=1.0MHz | - | 90 | - | PF | | |
| Reverse Transfer Capacitance | C _{rss} | F-1.0IVITZ | - | 3 | - | PF | | |
| Switching Characteristics (Note 4) | | | | | | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 10 | - | nS | | |
| Turn-on Rise Time | t _r | V _{DD} =100V, R _L =15Ω | - | 12 | - | nS | | |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =10 V , R_{G} =2.5 Ω | - | 15 | - | nS | | |
| Turn-Off Fall Time | t _f | | - | 15 | - | nS | | |
| Total Gate Charge | Qg | \/ -100\/ L -24 | - | 12 | | nC | | |
| Gate-Source Charge | Q_{gs} | V_{DS} =100V, I_{D} =2A, V_{GS} =10V | - | 2.5 | - | nC | | |
| Gate-Drain Charge | Q_{gd} | V _{GS} =10V | - | 3.8 | - | nC | | |
| Drain-Source Diode Characteristics | | | | | | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =2A | - | - | 1.2 | V | | |
| Diode Forward Current (Note 2) | Is | | - | - | 2 | Α | | |

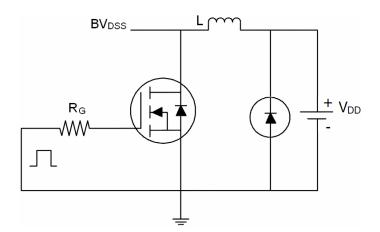
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

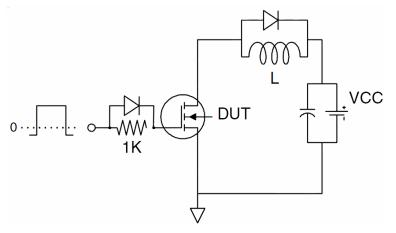


Test Circuit

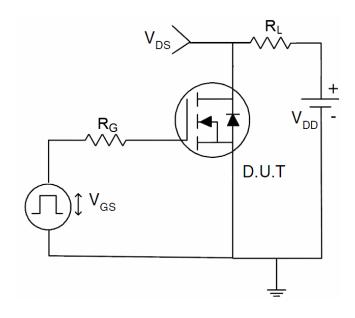
1) E_{AS} test circuit



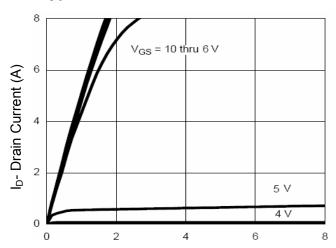
2) Gate charge test circuit



3) Switch Time Test Circuit

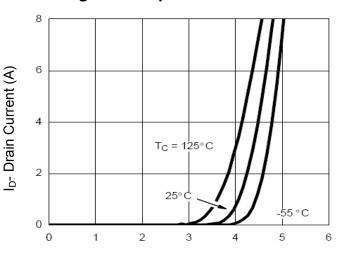


Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

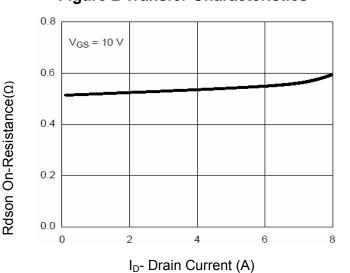
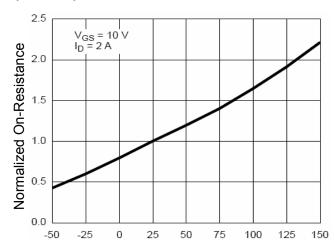
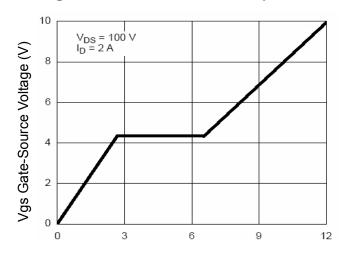


Figure 3 Rdson- Drain Current



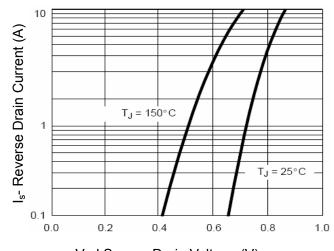
T_J-Junction Temperature(°C)

Figure 4 Rdson-JunctionTemperature



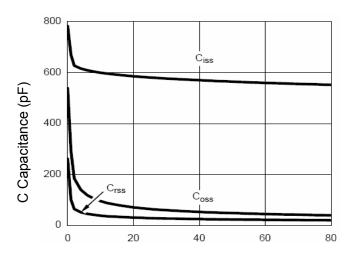
Qg Gate Charge (nC)

Figure 5 Gate Charge



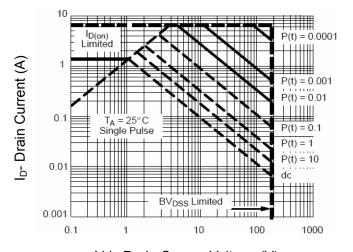
Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward



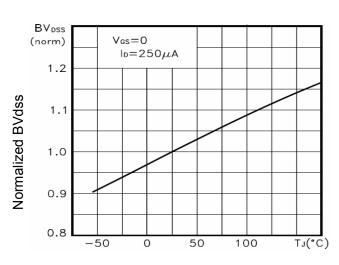
Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



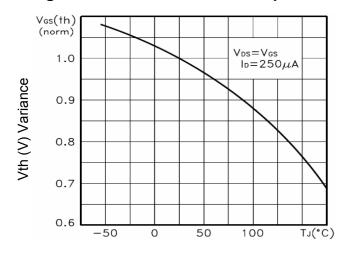
Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area



T_J-Junction Temperature(°C)

Figure 9 BV_{DSS} vs Junction Temperature



T_J-Junction Temperature(°C)

Figure 10 V_{GS(th)} vs Junction Temperature

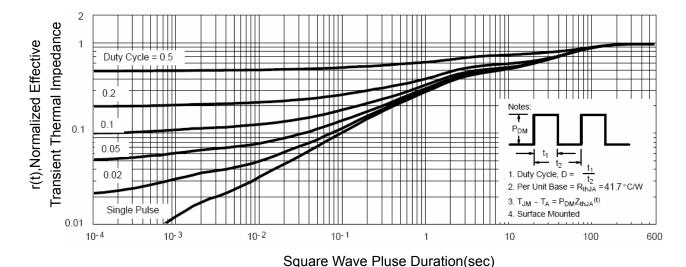
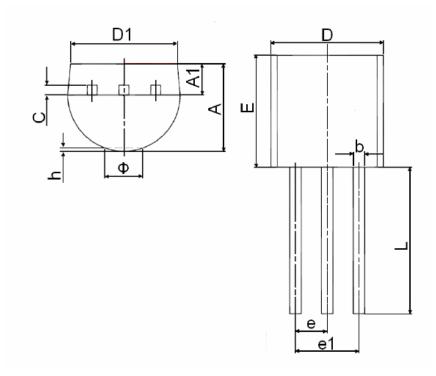


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-92 Package Information



| Symbol | Dimensions | In Millimeters | Dimensions In Inches | | | |
|--------|------------|----------------|----------------------|-------|--|--|
| Symbol | Min | Max | Min | Max | | |
| Α | 3.300 | 3.700 | 0.130 | 0.146 | | |
| A1 | 1.100 | 1.400 | 0.043 | 0.055 | | |
| b | 0.380 | 0.550 | 0.015 | 0.022 | | |
| С | 0.360 | 0.510 | 0.014 | 0.020 | | |
| D | 4.400 | 4.700 | 0.173 | 0.185 | | |
| D1 | 3.430 | | 0.135 | | | |
| E | 4.300 | 4.700 | 0.169 | 0.185 | | |
| е | 1.270 | TYP | 0.050 | TYP | | |
| e1 | 2.440 | 2.640 | 0.096 | 0.104 | | |
| L | 14.100 | 14.500 | 0.555 | 0.571 | | |
| Ф | | 1.600 | | 0.063 | | |
| h | 0.000 | 0.380 | 0.000 | 0.015 | | |

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- 5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

Pb-Free Product

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